

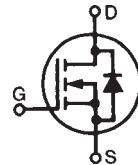
# High Current Power MOSFET

**IXTH 75N15**  
**IXTQ 75N15**  
**IXTT 75N15**

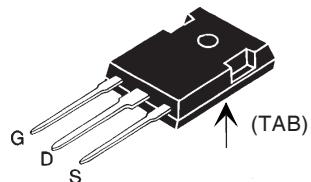
**V<sub>DSS</sub> = 150 V**  
**I<sub>D25</sub> = 75 A**  
**R<sub>DS(on)</sub> = 23 mΩ**

N-Channel Enhancement Mode

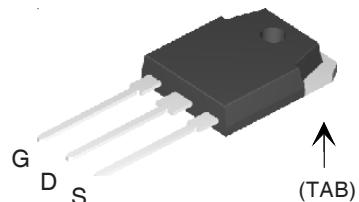
Preliminary Data Sheet



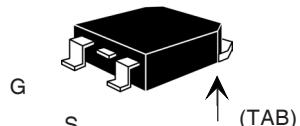
TO-247 AD (IXTH)



TO-3P (IXTQ)



TO-268 (IXTT)



G = Gate  
S = Source

D = Drain  
TAB = Drain

Symbol	Test Conditions	Maximum Ratings		
V <sub>DSS</sub>	T <sub>J</sub> = 25°C to 150°C	150	V	
V <sub>DGR</sub>	T <sub>J</sub> = 25°C to 150°C; R <sub>GS</sub> = 1 MΩ	150	V	
V <sub>GS</sub>	Continuous	±20	V	
V <sub>GSM</sub>	Transient	±30	V	
I <sub>D25</sub>	T <sub>C</sub> = 25°C	75	A	
I <sub>DM</sub>	T <sub>C</sub> = 25°C, pulse width limited by T <sub>JM</sub>	300	A	
I <sub>AR</sub>	T <sub>C</sub> = 25°C	75	A	
E <sub>AR</sub>	T <sub>C</sub> = 25°C	60	mJ	
E <sub>AS</sub>	T <sub>C</sub> = 25°C	1.5	J	
dv/dt	I <sub>S</sub> ≤ I <sub>DM</sub> , di/dt ≤ 100 A/μs, V <sub>DD</sub> ≤ V <sub>DSS</sub> , T <sub>J</sub> ≤ 150°C, R <sub>G</sub> = 2 Ω	5	V/ns	
P <sub>D</sub>	T <sub>C</sub> = 25°C	330	W	
T <sub>J</sub>		-55 ... +150	°C	
T <sub>JM</sub>		150	°C	
T <sub>stg</sub>		-55 ... +150	°C	
T <sub>L</sub>	1.6 mm (0.062 in.) from case for 10 s	300	°C	
M <sub>d</sub>	Mounting torque	1.13/10	Nm/lb.in.	
Weight	TO-247 AD, TO-3P	6	g	
	TO-268	4	g	

Symbol	Test Conditions (T <sub>J</sub> = 25°C, unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
V <sub>DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	150		V
V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0		4.0 V
I <sub>GSS</sub>	V <sub>GS</sub> = ±20 V <sub>DC</sub> , V <sub>DS</sub> = 0		±100	nA
I <sub>DSS</sub>	V <sub>DS</sub> = V <sub>DSS</sub> V <sub>GS</sub> = 0 V	T <sub>J</sub> = 25°C T <sub>J</sub> = 125°C	25 250	μA
R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 0.5 I <sub>D25</sub> Pulse test, t ≤ 300 μs, duty cycle d ≤ 2 %		23	mΩ

Features

- International standard packages
- Low R<sub>DS(on)</sub> HDMOS™ process
- Rugged polysilicon gate cell structure
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
  - easy to drive and to protect

## Advantages

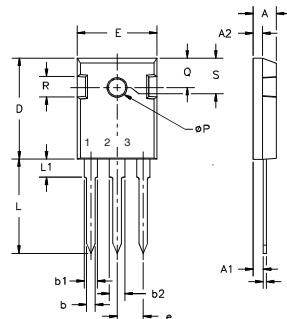
- Easy to mount
- Space savings
- High power density

**Symbol**      **Test Conditions**      **Characteristic Values**  
 $(T_J = 25^\circ\text{C}, \text{unless otherwise specified})$ 

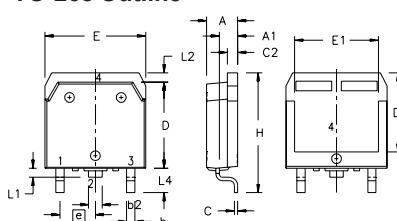
		Min.	Typ.	Max.
$g_{fs}$	$V_{DS} = 10 \text{ V}; I_D = 0.5 I_{D25}$ , pulse test	34	45	S
$C_{iss}$ $C_{oss}$ $C_{rss}$	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	3950	pF	
		1100	pF	
		420	pF	
$t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_D = 0.5 I_{D25}$ $R_G = 2 \Omega$ (External)	24	ns	
		33	ns	
		70	ns	
		17	ns	
$Q_{g(on)}$ $Q_{gs}$ $Q_{gd}$	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_D = 0.5 I_{D25}$	180	nC	
		33	nC	
		75	nC	
$R_{thJC}$	TO-247, TO-3P		0.35	K/W
$R_{thCK}$		0.21		K/W

**Source-Drain Diode**
**Characteristic Values**
 $(T_J = 25^\circ\text{C}, \text{unless otherwise specified})$ 

Symbol	Test Conditions	min.	typ.	max.
$I_s$	$V_{GS} = 0 \text{ V}$		75	A
$I_{SM}$	Repetitive		300	A
$V_{SD}$	$I_F = I_s, V_{GS} = 0 \text{ V}$ , Pulse test, $t \leq 300 \mu\text{s}$ , duty cycle $d \leq 2\%$		1.5	V
$T_{rr}$ $Q_{RM}$	$I_F = 25 \text{ A}$ -di/dt = 100 A/ $\mu\text{s}$ $V_R = 100 \text{ V}$	250	ns	
		2.0		$\mu\text{C}$

**TO-247 AD Outline**

 Terminals: 1 - Gate    2 - Drain  
 3 - Source    Tab - Drain

Dim.	Millimeter Min.	Millimeter Max.	Inches Min.	Inches Max.
A	4.7	5.3	.185	.209
A <sub>1</sub>	2.2	2.54	.087	.102
A <sub>2</sub>	2.2	2.6	.059	.098
b	1.0	1.4	.040	.055
b <sub>1</sub>	1.65	2.13	.065	.084
b <sub>2</sub>	2.87	3.12	.113	.123
C	.4	.8	.016	.031
D	20.80	21.46	.819	.845
E	15.75	16.26	.610	.640
e	5.20	5.72	.205	.225
L	19.81	20.32	.780	.800
L1		4.50		.177
ØP	3.55	3.65	.140	.144
Q	5.89	6.40	.232	.252
R	4.32	5.49	.170	.216
S	6.15	BSC	.242	BSC

**TO-268 Outline**

 Terminals: 1 - Gate    2 - Drain  
 3 - Source    Tab - Drain

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.185	.193	4.70	4.90
A1	.051	.059	1.30	1.50
A2	.057	.065	1.45	1.65
b	.035	.045	0.90	1.15
b2	.075	.087	1.90	2.20
b4	.114	.126	2.90	3.20
c	.022	.031	0.55	0.80
D	.780	.791	19.80	20.10
D1	.665	.677	16.90	17.20
E	.610	.622	15.50	15.80
E1	.531	.539	13.50	13.70
e	.215	BSC	5.45	BSC
L	.779	.795	19.80	20.20
L1	.134	.142	3.40	3.60
L2	.047	.055	1.20	1.40
ØP	.126	.134	3.20	3.40
ØP1	.272	.280	6.90	7.10
S	.193	.201	4.90	5.10

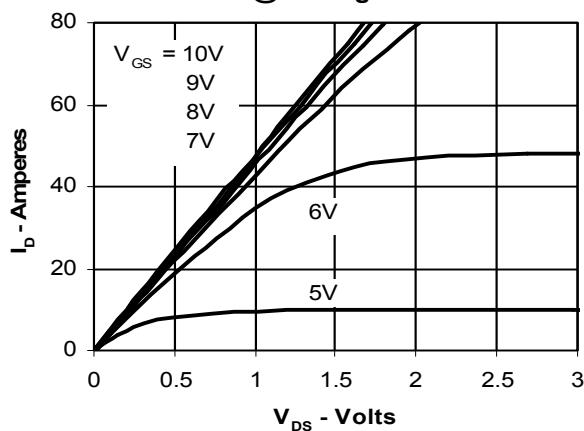
All metal areas are tin plated.

 1 - GATE  
 2 - DRAIN (COLLECTOR)  
 3 - SOURCE (EMITTER)  
 4 - DRAIN (COLLECTOR)

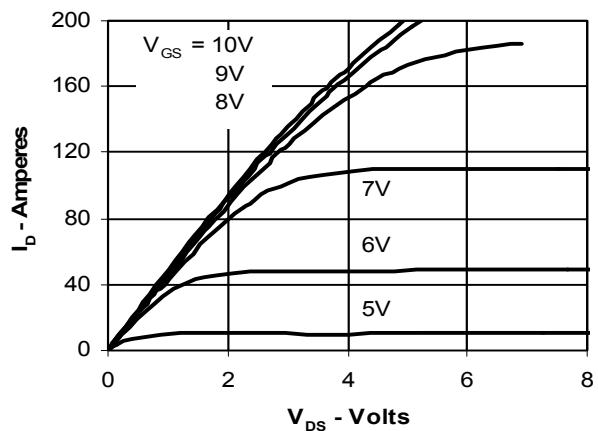
IXYS reserves the right to change limits, test conditions, and dimensions.

 IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents:  
 4,835,592    4,881,106    5,017,508    5,049,961    5,187,117    5,486,715    6,306,728B1    6,259,123B1    6,306,728B1  
 4,850,072    4,931,844    5,034,796    5,063,307    5,237,481    5,381,025    6,404,065B1    6,162,665    6,534,343

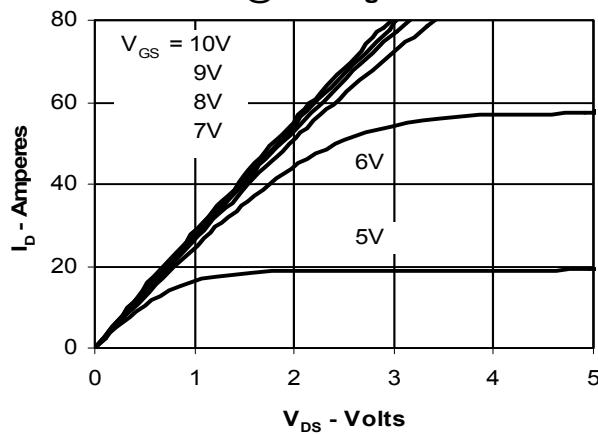
**Fig. 1. Output Characteristics  
@ 25 Deg. C**



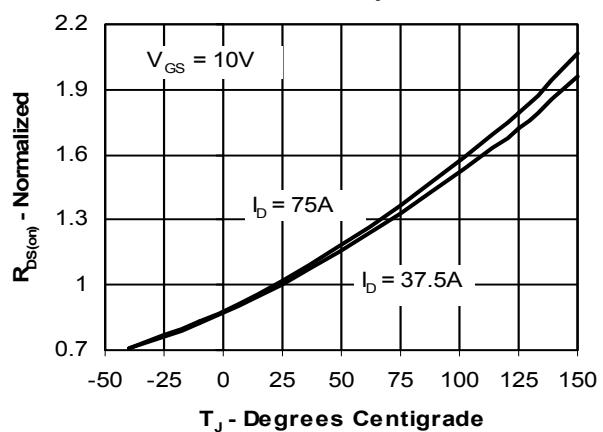
**Fig. 2. Extended Output Characteristics  
@ 25 deg. C**



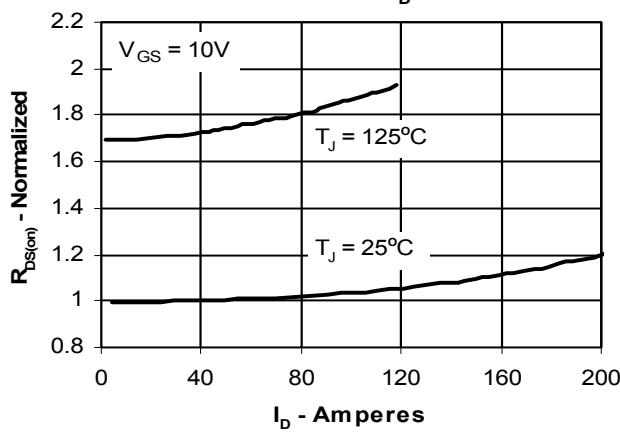
**Fig. 3. Output Characteristics  
@ 125 Deg. C**



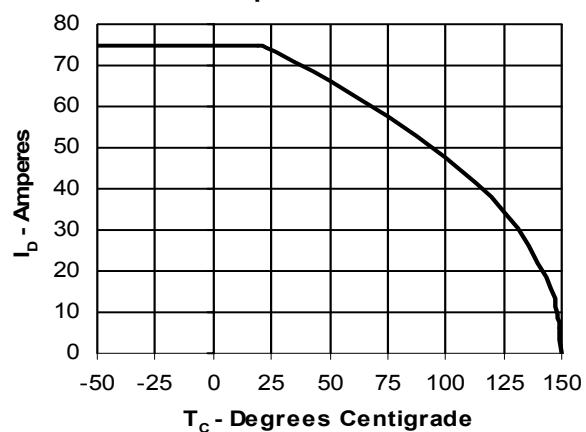
**Fig. 4.  $R_{DS(on)}$  Normalized to  $I_{D25}$  Value  
vs. Junction Temperature**

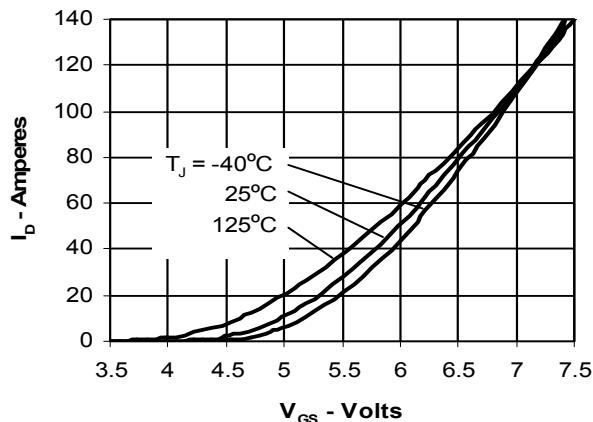
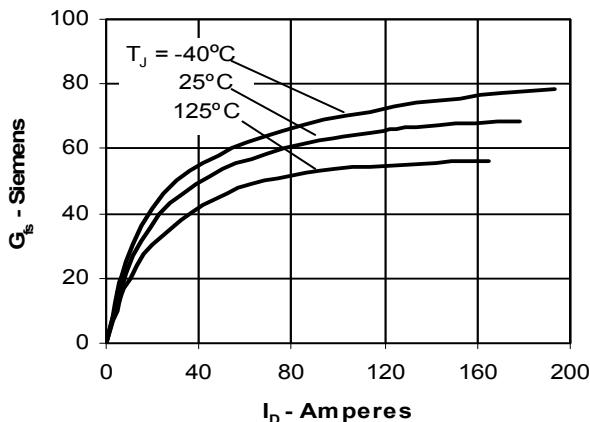
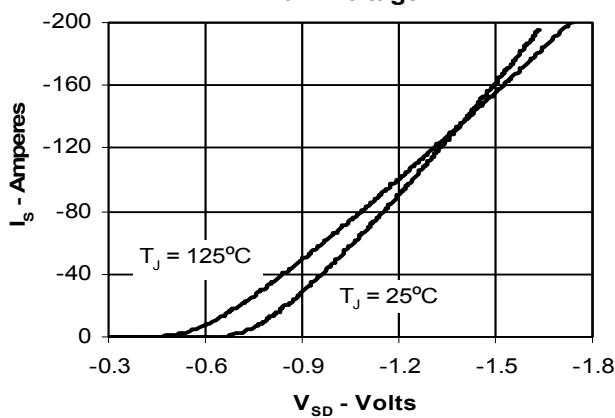
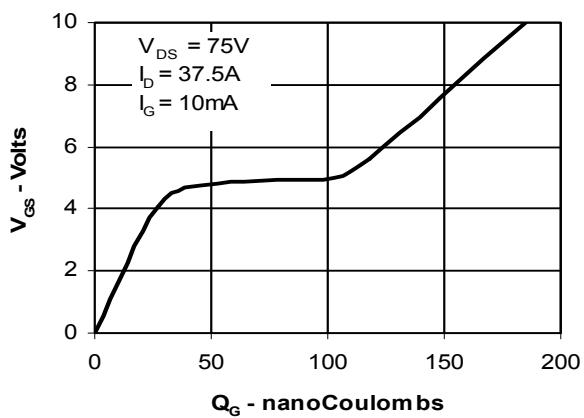
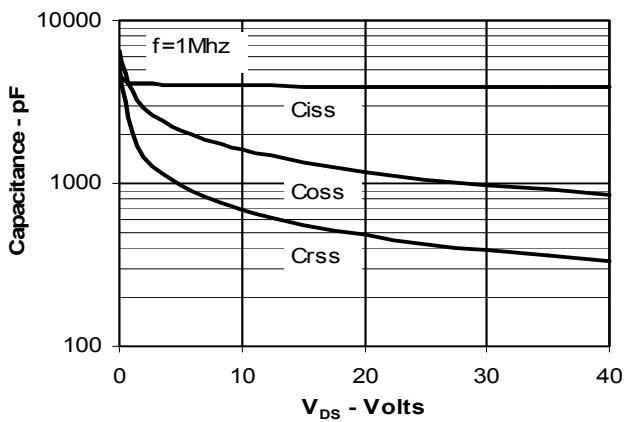
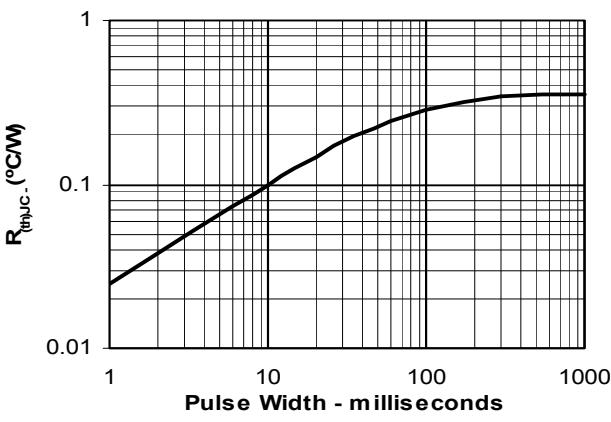


**Fig. 5.  $R_{DS(on)}$  Normalized to  $I_{D25}$   
Value vs.  $I_D$**



**Fig. 6. Drain Current vs. Case Temperature**



**Fig. 7. Input Admittance**

**Fig. 8. Transconductance**

**Fig. 9. Source Current vs. Source-To-Drain Voltage**

**Fig. 10. Gate Charge**

**Fig. 11. Capacitance**

**Fig. 12. Maximum Transient Thermal Resistance**


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